

## 60V N-Channel Enhancement Mode MOSFET

### Description

The NP6003MR uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### General Features

- ◆  $V_{DS} = 60V$   $I_D = 3A$   
 $R_{DS(ON)} = 75m\Omega$  @  $V_{GS} = 10V$  (Typ:  $80m\Omega$ )  
 $R_{DS(ON)} = 83m\Omega$  @  $V_{GS} = 4.5V$  (Typ:  $90m\Omega$ )
- ◆ High density cell design for ultra low  $R_{DS(on)}$ .
- ◆ Fully characterized avalanche voltage and current.
- ◆ Low gate to drain charge to reduce switching losses.

### Application

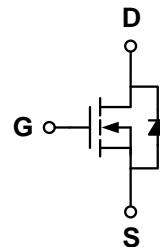
- ◆ Power switching application.
- ◆ Hard switched and high frequency circuits.
- ◆ Uninterruptible power supply.

### Package

- ◆ SOT-23-3L

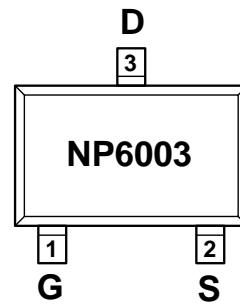


### Schematic diagram



### Marking and pin assignment

SOT-23-3L  
(TOP VIEW)



### Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
NP6003MR-G	-55°C to +150°C	SOT-23-3L	3000

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	$V_{DS}$	60	V
Gate-source voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D$	3	A
TC=70°C		2	
Pulsed Drain Current	$I_{DP}$	12	A
Maximum power dissipation	$P_D$	2	W
TC=25°C		1.4	
Power Dissipation – Derate above 25°C	TC=75°C		
Operating junction Temperature range	$T_j$	-55—150	°C

**Electrical Characteristics** (TA=25°C unless otherwise noted)

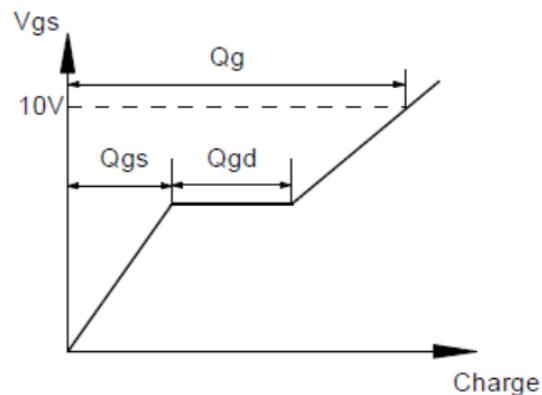
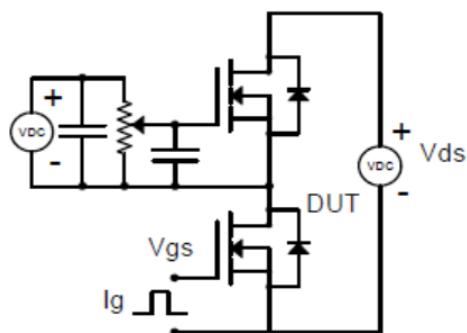
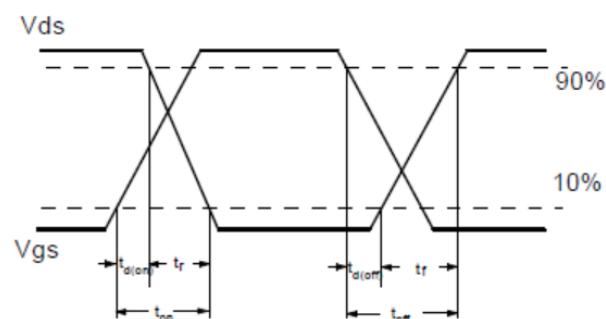
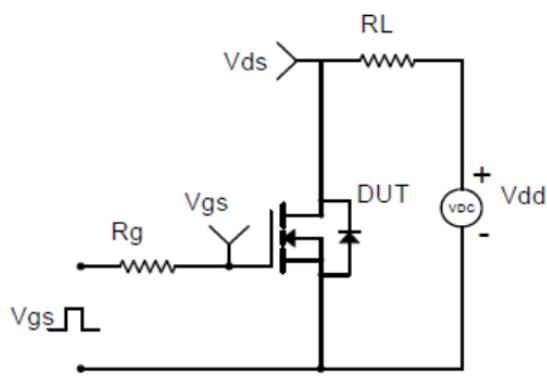
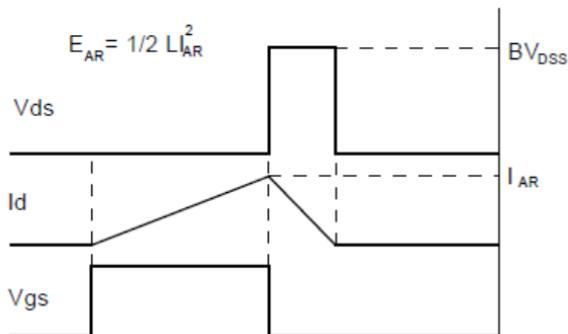
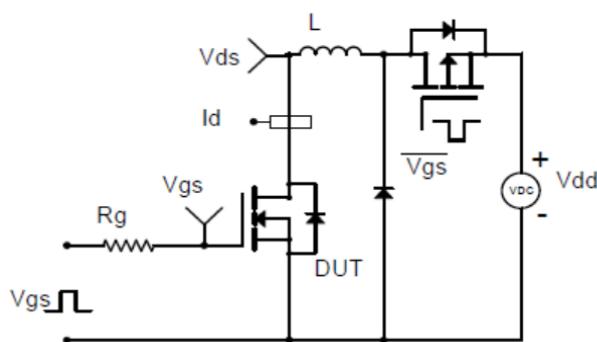
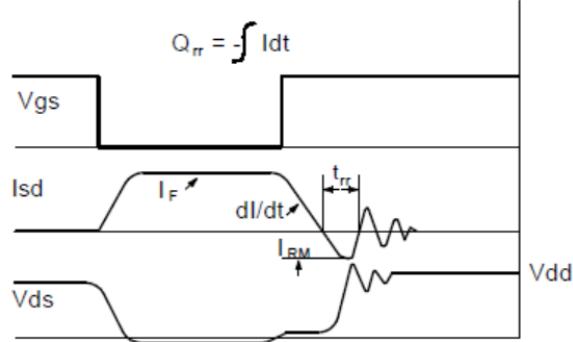
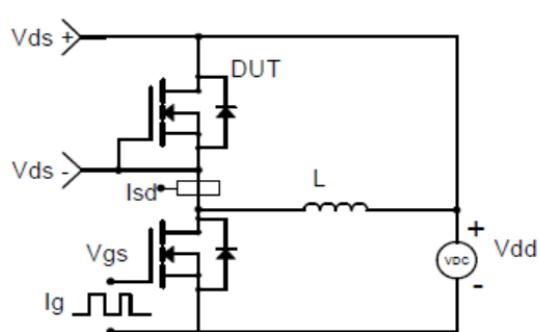
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60	-	-	V
BVDSS Temperature Coefficient	△BV <sub>DSS</sub> /△T <sub>J</sub>	Reference to 25°C, ID=1mA		33		mV/°C
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	-	-	1	μA
		T <sub>J</sub> =85°C	-	-	30	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V	-	-	±100	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.2	1.9	2.5	V
Drain-source on-state resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3A	-	75	90	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =2A		86	100	
On Status Drain Current	I <sub>D(ON)</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V	3	-	-	A
<b>Diode Characteristics</b>						
Diode Forward Voltage	V <sub>SD</sub>	I <sub>SD</sub> =1A, V <sub>GS</sub> =0V	-	0.75	1.1	V
Diode Continuous Forward Current	I <sub>S</sub>		-	-	3	A
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =1.5A, dI/dt=100A/us	-	15	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>		-	12	-	nC
<b>Dynamic Characteristics<sup>2</sup></b>						
Gate Resistance	R <sub>G</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	-	2.0	-	Ω
Input capacitance	C <sub>ISS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V f=1.0MHz	-	175	-	pF
Output capacitance	C <sub>OSS</sub>		-	21	-	
Reverse transfer capacitance	C <sub>RSS</sub>		-	13	-	
Turn-on delay time	t <sub>D(ON)</sub>	V <sub>GS</sub> =10V, V <sub>DD</sub> =30V, R <sub>L</sub> =4.7Ω, I <sub>D</sub> =1.5A, R <sub>G</sub> =3.3Ω	-	15	-	ns
Turn-on Rise time	t <sub>r</sub>		-	16	-	
Turn-off delay time	t <sub>D(OFF)</sub>		-	10	-	
Turn-off Fall time	t <sub>f</sub>		-	10	-	
Total gate charge	Q <sub>g</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =2A V <sub>DS</sub> =30V	-	4.1		nC
Gate-source charge	Q <sub>gs</sub>			0.8		
Gate-drain charge	Q <sub>gd</sub>		-	1	-	

Note: 1: Pulse test; pulse width ≤ 300ns, duty cycle ≤ 2%.

2: Guaranteed by design, not subject to production testing.

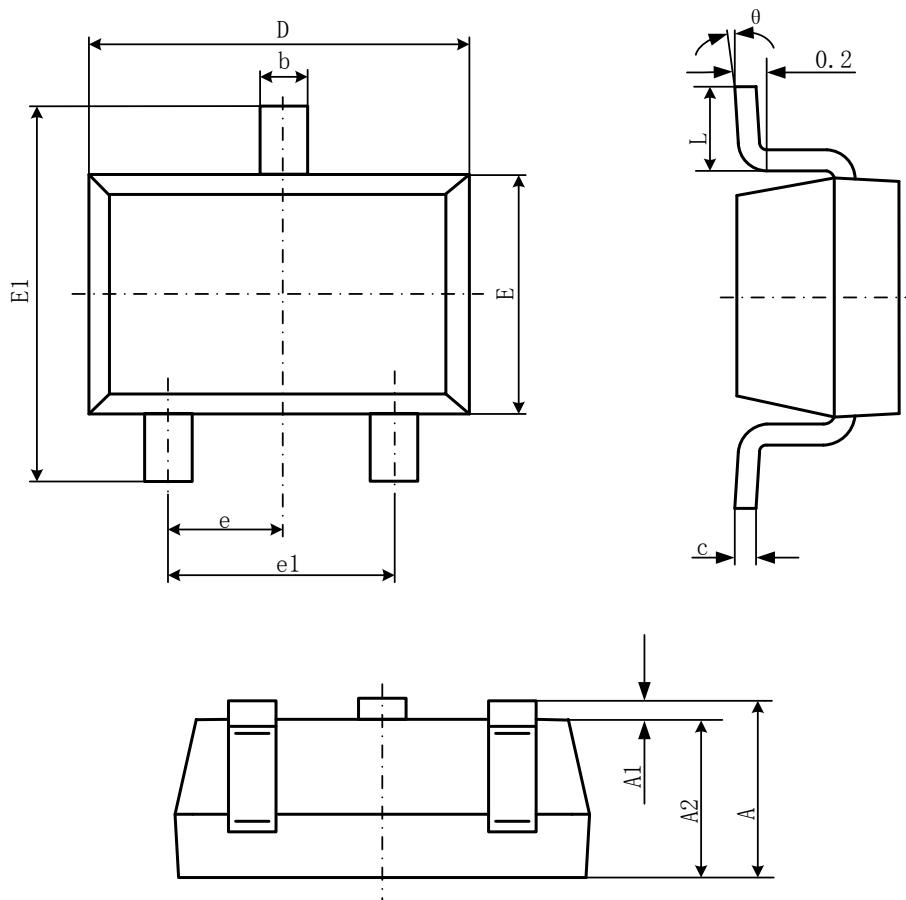
**Thermal Characteristics**

Parameter	Symbol	Typical	Unit
Thermal Resistance-Junction to Case	R <sub>θjc</sub>	60	°C/W
Thermal Resistance junction-to ambient	R <sub>θja</sub>	90	

**Gate Charge Test Circuit & Waveform**

**Resistive Switching Test Circuit & Waveforms**

**Unclamped Inductive Switching (UIS) Test Circuit & Waveforms**

**Diode Recovery Test Circuit & Waveforms**


## Package Information

- SOT-23-3L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
theta	0°	8°	0°	8°

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